Displaytech Ltd.

Website: www.displaytech-us.com.

LCD Module Product Specification

Product: SDT022ATFT
2.2" TFT Display Module (240RGBx320DOTS)

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7 March 2011.

Dis	play	ytech	Ltd

LCD MODULE

SDT022ATFT

Version: 1.0

1. REVISION RECORD

VERSION	CHANGES	DATE
1.0	Initial revision	7 March 2011

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2. Introduction

SDT022ATFT is a display module that contains a TFT display with a 320 * 240 RGB resolution. The driver used for this project is the Ilitek **ILI9340 or compatible** and can display 262K colors. The driver is mounted on the glass and the interconnection via FPC including components to drive the display module.

3. General Specifications

Item	Specification	Unit
LCD mode	Transmissive	
Resolution	240(RGB)	Line
Resolution	320	Line
Diagonal Size	2.2	Inch
Overall Size	41.70	mm
Overall Size	56.16	mm
Active area	33.84	mm
Active area	45.12	mm
Optimum Viewing Direction	6 o'clock	
Driver IC	ILI9340	
Interface type	MCU parallel / RGB (1)	
Colours	262K	
Operation temperature range (SDT022ATFT)	-20~70	°C
Storage temperature range (SDT022ATFT)	-30~80	°C

Remarks:

- (1) Serial interface is available, but not recommendable, as the speed of it is very slow.
- (2) Recommended mating connector: Hirose FH19SC-45S-0.5SH, FH12S-45S-0.5SH; or Molex 0512964593, 0512964594; or equivalent
- (3) Color tune may be changed slightly by temperature and driving voltage.
- (4) RoHS compliant.

Component Life Cycle

- 1) Storage Life: min. 1 Year
- 2) Operation Life (*1): min. 43 x 10³ h (24hr/day x 7days/week x 52weeks/year x 5years) (Not include backlight)
- 3) Storage and Operation Life Times are defined for a temperature of +25°C

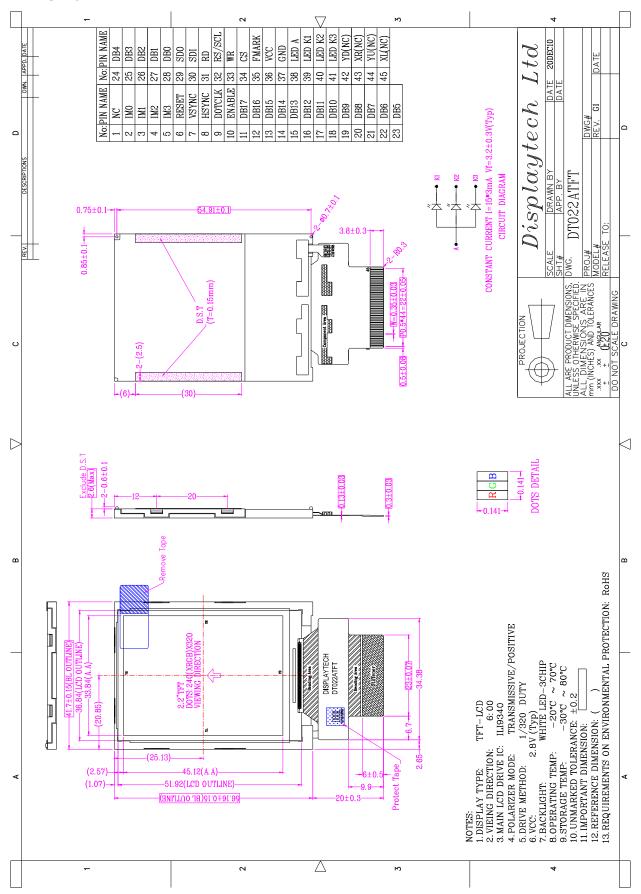
Notes:

- *1. Operation life ends when one of the listed faults occurs:
 - The on/off response-times reach 1.5 times of the max. value specified for a new display
 - The contrast is reduced to 0.5 of the original contrast value
 - Loss of function
 - The number of cosmetic defects exceeds the maximum defined

LCD MODULE

4. Mechanical Drawing

SDT022ATFT



5. Interface Description

Pin no	Symbol	I/O	Description								
1	NC			No connection							
							rface mode	DB Pin in o	ıse		
			IM3	IM2	IM1	IMO	MCU-Interface Mode	Register/Content	GRAM		
2	IM0		0	О	0	0	80 MCU 8-bit bus interface I	D[7:0]	D[7:0]		
			0	0	0	1	80 MCU 16-bit bus interface I	D[7:0]	D[15:0]		
			0	0	1	0	80 MCU 9-bit bus interface I	D[7:0]	D[8:0]		
			0	0	1	1	80 MCU 18-bit bus interface I	D[7:0]	D[17:0]		
3	IM1		0	1	0	1	3-wire 9-bit data serial interface I	SDA: In/O	UT		
		·	0	1	1	0	4-wire 8-bit data serial interface I	SDA: In/O			
		I	1	0	0	О	80 MCU 16-bit bus interface II	D[8:1]	D[17:10] D[8:1]		
			1	O	0	1	80 MCU 8-bit bus Interface II	D[17:10]	D[17:10],		
4	IM2		1	O	1	O	80 MCU 18-bit bus interface II	D[8:1]	D[17:0]		
			1	o	1	1	80 MCU 9-bit bus interface II	D[17:10]	D[17:9]		
			1	1	0	1	3-wire 9-bit data serial interface II	SDI: In SDO: Ot	ıt.		
			1	1	1	0	4-wire 8-bit data serial interface II	SDI: In SDO: Ou			
5	IM3		MPU	Paral	l lel int	erface	e bus and serial inter	•	11		
							nust select serial inte	erface.			
6	RESET	I			oin at	VDDI	l or VSS.				
				Reset pin. Frame synchronizing signal for RGB interface operation.							
7	VSYNC	I	1	Fix to VDDI or VSS level when not in use.							
8	HSYNC	I		Line synchronizing signal for RGB interface operation.							
				Fix to VDDI or VSS level when not in use.							
9	DOTCLK	I		Dot clock signal for RGB interface operation. Fix to VDDI or VSS level when not in use.							
10	ENABLE	I		Data enable signal for RGB interface operation. Fix to VDDI or VSS level when not in use.							
							nal data bus for MCU s	vstem and RGR in	terface mode		
11~28	DB17~DB0	I/O					t in use.	ystein una 1102 in	terrace mode		
							s] setting.				
- 0	an a		Serial					· ·			
29	SDO	О	1		-		the falling edge of the S	CL signal.			
			If not u				l in/out signal.				
2.0	an 1	_					al input signal.				
30	SDI	I					e rising edge of the SCI	z signal.			
							VDDI or VSS.				
2.1	22	-			O-II sy	stem (RDX): Serves as a read	signal and MCU r	ead data at the		
31	RD	I	rising e	_	or VC	S loval	when not in use.				
							"Data or Command" in	the parallel interfa	ice or 4-wire 8-		
			bit seri				Data of Command III	and paramer miteria	ice of 1 wife 0.		
			When	RS = '	1', da	ta is se					
32	RS/SCL	I					d is selected.				
					sed ser	ial inte	erface clock in 3-wire 9	-bit / 4-wire 8-bit	serial data		
			interfa		hic nin	chou!	d ha connected to UDF	N or VSS			
							$\frac{d}{d}$ be connected to VDE (WRX): Serves as a wi		es data at the		
2.2	1175	_	rising		O 11 3	. j swiii	(,, 101). Dei ves as a wi	signai and will	cs ann at tile		
33	WR	I			m (D/0	CX): S	Serves as command or p	arameter select.			
			Fix to	VDDI	or VS	S level	when not in use.				
34	CS	I	Chip select input pin ("Low" enable).								
_			This pin can be permanently fixed "Low" in MPU interface mode only.								

Pin no	Symbol	I/O	Description
			Tearing effect output pin to synchronize MPU to frame writing, activated by S/W
35	FMARK	О	command. When this pin is not activated, this pin is low.
			If not used, open this pin.
36	VCC		Power supply 2.8V
37	GND		Power ground 0V
38	LEDA		Backlight anode.
39	LED K1		Backlight cathode K1
40	LED K2		Backlight cathode K2
41	LED K3		Backlight cathode K3
42	NC (YD)		No connection (YD of touch screen)
43	NC (XR)		No connection (XR of touch screen)
44	NC (YU)		No connection (YU of touch screen)
45	NC (XL)		No connection (XL of touch screen)

6. Absolute Maximum Ratings

 $(Ta=25^{\circ}C)$

Item	Symbol	Min.	Max.	Unit
Power supply voltage	VCC	-0.3	+ 4.6	V
Logic signal input/output voltage	Vcc	-0.3	+ 4.6	V
Operating Temperature	ТОР	-20	+70	°C
Storage Temperature	TST	-30	+80	°C

Note:

- When temperature is below 0°C, the response time of liquid crystal (LC) will be slower and the color of panel will be darker.
- If module driving condition exceeds the absolute maximum ratings, permanent damaged may be resulted. If module is driven within the absolute maximum ratings but exceeded the DC characteristics, mal-function may be resulted.
- VDD/VCC > VSS

7. Electrical Characteristics

DC Characteristics

 $(Vss=0V, Ta=25^{\circ}C)$

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power supply	VCC / VDD		2.5	2.8	3.3	V
Input voltage "H"	VIH		0.7 VCC		VCC	V
Input voltage "L"	VIL		VSS		0.3 VCC	V
Output voltage "H"	VOH	IOL=-1.0mA	0.8 VCC		VCC	V
Output voltage "L"	VOL	IOL=1.0mA	VSS		0.2 VCC	V

8. Display Controller /Power Supply Timing

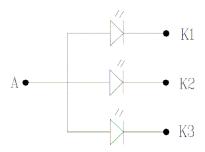
See Display Controller Specification: Ilitek ILI9340

9. Backlight specification

(Vcc=3.0V, Vss=0V, Ta=25°C)

					1		, ,
Item	Symbol	Condition	Min	Тур	Max	Unit	Note
Supply voltage	Vf	If=15mA x3	2.9		3.5	V	1
Forward current	If			45		mA	2
Uniformity	ΔBp		80			%	
Color coordination	X	If=45mA	0.265		0.315	-	
	Y		0.265		0.315		

LED circuit diagram:



Constant current If=15x3mA; Vf=3.2±0.3V(typ)

Note:

- 1) The LED's driver mode needs to be constant current mode.
- 2) Permanent damage to the device may occur if maximum values are exceeded. Functional operation should be restricted to the conditions described under normal operating conditions.

10.Optical Characteristics

(Vcc=3.0V, Vss=0V, Ta=25°C)

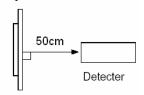
								V, Ta=25°C)
Ite	em	Symbol	Condition	Min	Тур	Max	Unit	Note
Brightness		Вр	$\theta=0^{\circ}$	180	200		cd/m²	1
Uniformity		ΔBp	Ф=0°	80			%	1, 2
		θ1						
		(Φ=90°			-60 ~ 50			
		or 270°)						
Viewing An	gle	θ2	Cr≥10				deg	3
		(Ф=0°		-70 ~ 70				
				270 % 70				
		180°) Cr						
Contrast ra	Contrast ratio		$\theta=0^{\circ}$		350			4
Response Ti	Response Time		Ф=0°		20	30	ms	5
Response 11		Tf	4- 0				1115	<u> </u>
	White	X		0.2408	0.2908	0.3408		
5 .	Willie	у		0.2818	0.3318	0.3818		
y) icit	Red	X		0.4911	0.5411	0.5911		
(x, natj	Ku	y	$\theta=0^{\circ}$	0.3035	0.3535	0.4035		
JE .	Green	X	Φ=0°	0.2741	0.3241	0.3741		1, 6
CIE (x,y) Chromaticity	Gitti	у	4-0	0.4947	0.5447	0.5947		
	Blue	X		0.1055	0.1555	0.2055		
Diue		y		0.0839	0.1339	0.1839		
NTSC Ratio)	S			38		%	

Note 1: The data are measured after LEDs are turned on for 5 minutes. LCM displays full white. The brightness is the average value of 9 measured spots. Measurement equipment PR-705 (Φ8mm)

Measuring condition:

- Measuring surroundings: Dark room.
- Measuring temperature: Ta=25°C.
- Adjust operating voltage to get optimum contrast at the center of the display.

Measured value at the center point of LCD panel after more than 5 minutes while backlight turning on.

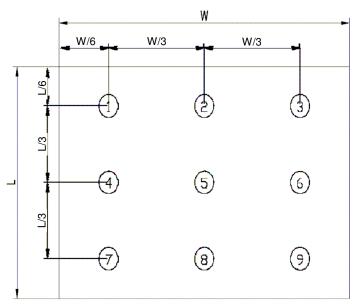


Note 2: The luminance uniformity is calculated by using following formula.

 $\Delta Bp = Bp (Min.) / Bp (Max.) \times 100 (\%)$

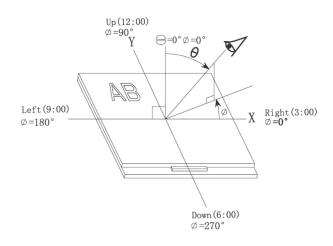
Bp (Max.) = Maximum brightness in 9 measured spots

Bp (Min.) = Minimum brightness in 9 measured spots.



Measurement equipment PR-705 (Φ8mm)

Note 3: The definition of viewing angle: Refer to the graph below marked by θ and Φ



Note 4: The definition of contrast ratio (Test LCM using PR-705):

Contrast Ratio (CR) = Luminance When LCD is at "White" state

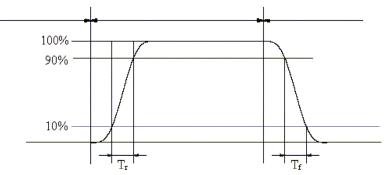
Luminance When LCD is at "Black" state

(Contrast Ratio is measured in optimum common electrode voltage)

Note 5: Definition of Response time. (Test LCD using DMS501):

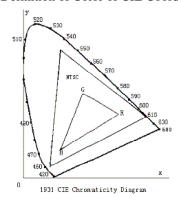
The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively.

The response time is defined as the time interval between the 10% and 90% of amplitudes. Refer to figure as below.



The definition of response time

Note 6: Definition of Color of CIE Coordinate and NTSC Ratio.



Color gamut:

$$S = \frac{\text{area of RGB triangle}}{\text{area of NTSC triangle}} \times 100\%$$

11. Safety Precaution

Handling precautions:

This device is susceptible to Electro-Static Discharge (ESD) damage. Observe Anti-Static precautions.

Power supply precautions:

- Identify and, at all times, observe absolute maximum ratings for both logic and LC drivers. Note that there is some variance between models.
- Prevent the application of reverse polarity to VCC and GND, however briefly.
- Use a clean power source free from transients. Power up conditions are occasionally "jolting" and may exceed the maximum ratings of the modules.
- The VCC power of the module should also supply the power to all devices that may access the display. Don't allow the data bus to be driven when the logic supply to the module is turned off.

Operating precautions:

- DO NOT plug or unplug the module when the system is powered up.
- Minimize the cable length between the module and host MPU.
- Operate the module within the limits of the modules temperature specifications.

Mechanical/Environmental precautions:

- Improper soldering is the major cause of module difficulty. Use of flux cleaner is not recommended as they may seep under the elastomeric connection and cause display failure.
- Mount the module so that it is free from torque and mechanical stress.
- Surface of the LCD panel should not be touched or scratched. The display front surface is an easily scratched, plastic polarizer. Avoid contact and clean only when necessary with soft, absorbent cotton dampened with petroleum benzene.
- Always employ anti-static procedure while handling the module.
- Prevent moisture build-up upon the module and observe the environmental constraints for storage temperature and humidity.
- Do not store in direct sunlight
- If leakage of the liquid crystal material should occur, avoid contact with this material, particularly ingestion. If the body or clothing becomes contaminated by the liquid crystal material, wash thoroughly with water and soap